

FIPS 140-2 Non-Proprietary Security Policy Document Revision: 1.0

H/W version: MZWLL1T9HAJQ-000C9, MZWLL3T8HAJQ-000C9, MZWLL7T6HMLA-000C9, MZWLL15THMLA-000C9

F/W version: GPJ95E5Q, GPJ99E5Q and GPJ9DE5Q



Revision History

Author(s)	Version	Updates
Seungjae Lee	1.0	Initial Version



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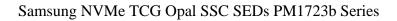
1. Introduction

Samsung Electronics Co., Ltd. ("Samsung") NVMe TCG Opal SSC SEDs PM1723b Series, herein after referred to as a "cryptographic module" or "module", SSD (Solid State Drive), satisfies all applicable FIPS 140-2 Security Level 2 requirements, supporting TCG Opal SSC based SED (Self-Encrypting Drive) features, designed to protect unauthorized access to the user data stored in its NAND Flash memories. The built-in AES HW engines in the cryptographic module's controller provide on-the-fly encryption and decryption of the user data without performance loss. The SED's nature also provides instantaneous sanitization of the user data via cryptographic erase.

Module Name	Hardware Version	Firmware Version	Drive Capacity
	MZWLL1T9HAJQ-000C9	GPJ95E5Q,	1.92TB
Samsung NVMe TCG Opal SSC SEDs PM1723b	MZWLL3T8HAJQ-000C9		3.84TB
Series	MZWLL7T6HMLA-000C9	GPJ99E5Q and GPJ9DE5Q	7.68TB
	MZWLL15THMLA-000C9	GRIEDEDQ	15.3TB

Exhibit 1 – Versions of Samsung NVMe TCG Opal SSC SEDs PM1723b Series.







The following photographs show the cryptographic module's top and bottom views. The multiple-chip standalone cryptographic module consists of hardware and firmware components that are all enclosed in two aluminum alloy cases, which serve as the cryptographic boundary of the module. The top and bottom cases are assembled by screws and the tamper-evident labels are applied for the detection of any opening of the cases. No security relevant component can be seen within the visible spectrum through the opaque enclosure. New firmware versions within the scope of this validation must be validated through the FIPS 140-2 CMVP. Any other firmware loaded into this module is out of the scope of this validation and requires a separate FIPS 140-2 validation.



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<u>Exhibit 2</u> – Specification of the Samsung NVMe TCG Opal SSC SEDs PM1723b Series MZWLL1T9HAJQ-000C9 Cryptographic Boundary (From top to bottom – Left to right: top side, bottom side, front side, back side, left side, and right side).





<u>Exhibit 3</u> – Specification of the Samsung NVMe TCG Opal SSC SEDs PM1723b Series MZWLL3T8HAJQ-000C9 Cryptographic Boundary (From top to bottom – Left to right: top side, bottom side, front side, back side, left side, and right side).





<u>Exhibit 4</u> – Specification of the Samsung NVMe TCG Opal SSC SEDs PM1723b Series MZWLL7T6HMLA-000C9 Cryptographic Boundary (From top to bottom – Left to right: top side, bottom side, front side, back side, left side, and right side).

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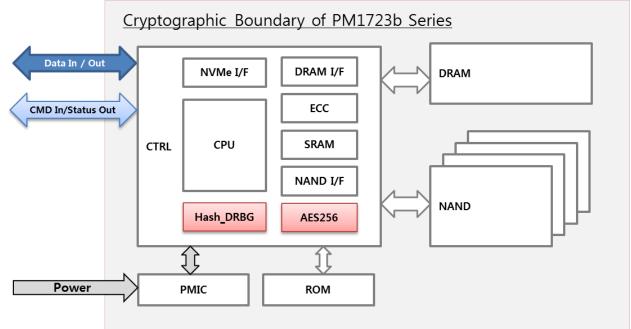


<u>Exhibit 5</u> – Specification of the Samsung NVMe TCG Opal SSC SEDs PM1723b Series MZWLL15THMLA-000C9 Cryptographic Boundary (From top to bottom – Left to right: top side, bottom side, front side, back side, left side, and right side).



1.2. Firmware and Logical Cryptographic Boundary

The PM1723b series use a single ship controller with a NVMe interface on the system side and Samsung NAND flash internally. The following figure depicts the Module operational environment.



<u>Exhibit 6</u> – Block Diagram for Samsung NVMe TCG Opal SSC SEDs PM1723b Series.



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2. Acronym

Acronym	Description
CTRL	EPiC2 Controller (SAMSUNG EPiC2 NVMe TLC/MLC
	SSD Controller)
NVMe I/F	Non-Volatile Memory Express Interface
CPU	Central Processing Unit (ARM-based)
DRAM I/F	Dynamic Random Access Memory Interface
ECC	Error Correcting Code
SRAM	Static Random Access Memory
NAND I/F	NAND Flash Interface
PMIC	Power Management Integrated Circuit
ROM	Read-only Memory
DRAM	Dynamic Random Access Memory
NAND	NAND Flash Memory
LBA	Logical Block Address
MEK	Media Encryption Key
MSID	Manufactured SID(Security Identifier)

<u>Exhibit 7</u> – Acronym and Descriptions for Samsung NVMe TCG Opal SSC SEDs PM1723b Series.





3. Security Level Specification

Security Requirements Area	Level
Cryptographic Module Specification	2
Cryptographic Module Ports and Interfaces	2
Roles, Services, and Authentication	2
Finite State Model	2
Physical Security	2
Operational Environment	N/A
Cryptographic Key Management	2
EMI/EMC	3
Self-tests	2
Design Assurance	2
Mitigation of Other Attacks	N/A

Exhibit 8 – Security Level Table.



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4. Cryptographic Functionality

4.1. Approve algorithms

The cryptographic module supports the following Approved algorithms for secure data storage:

CAVP	Algorithm	Standard	Mode /	Key Lengths,	Use
Cert.			Method	Curves or Moduli	
5007	AES	FIPS 197	XTS	256-bit	Data Encryption
		SP 800-38E			/ Decryption
					Note: AES-ECB is the pre-requisite for AES- XTS; AES-ECB alone is NOT supported by the cryptographic module in FIPS Mode.
Vendor Affirmed	CKG	SP800-133			Cryptographic Key Generation
1845	DRBG	SP 800-90A	Hash_ DRBG		Deterministic
		Revision 1	(SHA-256)		Random Bit
					Generation
1288	ECDSA	FIPS 186-4	SigVer	P-224	Digital Signature Verification
4072	SHS	FIPS 180-4	SHA-256		Message Digest

<u>Exhibit 9 -</u> Samsung NVMe TCG Opal SSC SEDs PM1723b Series Approved Algorithms.

NOTE 1: This module supports AES-XTS which is only approved for storage applications.





4.2. Non-Approved Algorithm

The cryptographic module supports the following non-Approved but allowed algorithms:

Algorithm	Use
NDRNG	Non-deterministic Random Number Generator
	(only used for generating seed materials for the
	Approved DRBG)
	NDRNG provides a minimum of 440 bits of entropy
	for DRBG seed

<u>Exhibit 10 -</u> Samsung NVMe TCG Opal SSC SEDs PM1723b Series non-Approved but allowed algorithms.



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4.3. Critical Security Parameters

The cryptographic module contains the following Keys and CSPs:

CSPs	Generation, Storage and Zeroization Methods
DRBG Internal State	Generation: SP 800-90A HASH_DRBG (SHA-256) Storage: Plaintext in SRAM
Note: The values of V and	Zeroization: via "Initialization", "Erase an LBA Range's Data",
C are the "secret values" of the internal state.	"Change the Password" and "Zeroize" service
DRBG Seed	Generation: NDRNG
	Storage: Plaintext in DRAM
	Zeroization: via "Initialization", "Erase an LBA Range's Data", "Change the Password" and "Zeroize" service
DRBG Entropy Input	Generation: NDRNG
String	Storage: Plaintext in DRAM
	Zeroization: via "Initialization", "Erase an LBA Range's Data",
	"Change the Password" and "Zeroize" service
CO Password	Generation: N/A
	Storage: Plaintext in Flash Memory and used in SRAM
	Zeroization: via "Initialization", "Change the Password" and
	"Zeroize" service
User Password	Generation: N/A
	Storage: Plaintext in Flash Memory and used in SRAM
	Zeroization: via "Initialization" service, "Erase an LBA Range's Data" and "Zeroize" service
МЕК	Generation: SP 800-90A HASH_DRBG (SHA-256)
	As per SP 800-133 Section 7.1, key generation is performed as
	per the "Direct Generation: of Symmetric Keys" which is an
	Approved key generation method
	Key Type: AES-XTS 256
	Storage: Plaintext in Flash Memory and used in SRAM
	Zeroization: via "Initialization", "Lock an LBA Range", "Erase an
	LBA Range's Data" and "Zeroize" service

Exhibit 11– CSPs and details on Generation, Storage and Zeroization Methods.

NOTE 2: In accordance with FIPS 140-2 IG D.12, the cryptographic module performs Cryptographic Key Generation (CKG) as per SP 800-133 (Vendor Affirmed). The resulting generated symmetric key is the unmodified output from SP 800-90A DRBG.

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4.4. Public Security Parameters

Public Keys	Generation, Storage and Zeroization Methods
FW Verification Key	Generation: N/A
(ECDSA Public Key)	Key Type: ECDSA P-224
	Storage: Plaintext in Flash Memory and used in SRAM
	Zeroization: N/A

<u>Exhibit 12</u> – Public Keys and details on Generation, Storage and Zeroization Methods



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5. Physical Ports and Logical Interfaces

Physical Port	Logical Interface
	Data Input/Output
NVMe Connector	Control Input
	Status Output
	Power Input

<u>Exhibit 13</u> – Specification of the Samsung NVMe TCG Opal SSC SEDs PM1723b Series Cryptographic Module Physical Ports and Logical Interfaces.



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6. Roles, Services and Authentication

6.1. Roles

The following table defines the roles, type of authentication, and associated authenticated data types supported by the cryptographic module:

Role	Authentication Data
CO Role	Password
User Role	Password
FW Loader	ECDSA

Exhibit 14 - Roles and Required Identification and Authentication (FIPS 140-2 Table C1).



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6.2. Authentication

The authentication mechanism allows a minimum 6-byte length or longer (32-byte) Password, where each byte can be any of 0x00 to 0xFF, for every Cryptographic Officer and User role supported by the module, which means a single random attempt can succeed with the probability of $1/2^{48}$ or lower.

Each Password authentication attempt takes at least 5ms and the number of attempts is limited to TryLimit, a configurable parameter which is set to 33 in manufacturing time. Since the module takes at least 4 seconds to be ready after power-on and 33 authentication failures require a power-cycle, it would take a total of 4165ms ((5ms *33) + 4000ms) for every 33^{rd} authentication attempt. Therefore the number of attempts possible in a minute period is limited to only 495 attempts (60000ms == (5ms*33) + 4000ms)*14 + (5ms * 33 attempts) + 1525).

Therefore, the probability of multiple random attempts to succeed in one minute is $495 / 2^{48}$, which is much less than the FIPS 140-2 requirement 1/100,000.

The authentication mechanism for FW Loader role is ECDSA P-224 with SHA256 digital signature verification, which means a single random attempt, can succeed with the probability of $1/2^{112}$.

Each ECDSA Signature Verification authentication attempt takes at least 600ms. Since the module takes at least 4 seconds to be ready after power-on, it would take a total of 4600ms for every FW download attempt. This enforces the maximum number of attempts to be no more than 13 attempts (60000ms/4600ms) in a minute period. Therefore, the probability of multiple random attempts to succeed in one minute is $13/2^{112}$, which is much less than the FIPS 140-2 requirement 1/100,000.

Authentication Mechanism	Strength of Mechanism
Password (Min: 6 bytes, Max: 32 bytes) Authentication	 Probability of 1/2⁴⁸ in a single random attempt Probability of 495/2⁴⁸ in multiple random attempts in a minute
ECDSA Signature Verification	 Probability of 1/2¹¹² in a single random attempt Probability of 13/2¹¹² in multiple random attempts in a minute

Exhibit 15 - Strengths of Authentication Mechanisms (FIPS 140-2 Table C2).

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6.3. Services

6.3.1. Authenticated Services

The following table lists roles, services, cryptographic keys, CSPs and Public Keys and the types of access that are available to each of the authorized roles via the corresponding services:

Role	Service	Cryptographic Keys, CSPs and Public Keys	Type(s) of Access			
			R=	W=	G=	Z=
			Read	Write	Generate	Zeroize
		DRBG Internal State	0		0	0
		DRBG Seed	0		0	0
	Initialization	DRBG Entropy Input String	0		0	0
		CO Password		0		0
		MEK			0	0
	Drive Extended Status	N/A	N/A			
Cryptographic	Admin/User Authority Enable/Disable	N/A	N/A			
Officer	Lock an LBA Range	MEK				0
	Unlock an LBA Range	MEK	0			
	Configure an LBA Range	N/A	N/A			
	Erase an LBA Range's Data	DRBG Internal State	0		0	0
		DRBG Seed	0		0	0
		DRBG Entropy Input String	0		0	0
		MEK			0	0
	Change the Password.	CO Password		0		0
User	Unlock an LBA Range	MEK	0			
	Set User Password	User Password		0		
	Lock an LBA Range	MEK				0
	Configure an LBA Range	N/A	N/A			
FW Loader	Update the firmware	FW Verification Key	0			

* Type(s) of Access indicated using "O" marker.

<u>Exhibit 16</u> – Services Authorized for Roles, Access Rights within Services (FIPS 140-2 Table C3, Table C4).

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6.3.2. Unauthenticated Services

The following table lists the unauthenticated services:

* Type(s) of Access indicated using "O" marker.

	Unauthenticated Service	Cryptographic Keys & CSPs		Type(s) of Access			
Role			R=	W=	G=	Z=	
			Read	Write	Generate	Zeroize	
Cryptographic Officer, User and FW Loader	Zeroize	DRBG Internal State				0	
		DRBG Seed				0	
		DRBG Entropy Input String				0	
		CO Password				0	
		User Password				0	
		MEK				0	
Cryptographic Officer, User and FW Loader	Get Random Number	DRBG Internal State	0		0	0	
		DRBG Seed	0		0	0	
		DRBG Entropy Input String	0		0	0	
Cryptographic Officer, User and FW Loader	Get MSID	N/A	N/A				
Cryptographic Officer, User and FW Loader	Show Status	N/A	N/A				
Cryptographic Officer, User and FW Loader	Self-test	N/A		Ν	J/A		

<u>Exhibit 17</u> – Unauthenticated Service, Cryptographic Keys & CSPs and Type(s) of Access.



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7. Physical security policy

The following physical security mechanisms are implemented in a cryptographic module:

- The Module consists of production-grade components enclosed in an aluminum alloy enclosure, which is opaque within the visible spectrum. The top panel of the enclosure can be removed by unscrewing screws. However, the module is sealed with tamper-evident labels in accordance with FIPS 140-2 Level 2 Physical Security requirements so that tampering is easily detected when the top and bottom cases are detached.
- 2 tamper-evident labels are applied over both top and bottom cases of the module at the factory. The tamper-evident labels are not removed and reapplied without tamper evidence.
- The tamper-evident labels are applied by Samsung at Manufacturing.

The following table summarizes the actions required by the Cryptographic Officer Role to ensure that physical security is maintained:

Physical Security Mechanisms	Recommended Frequency of Inspection/Test	Inspection/Test Guidance Details
Production grade cases	As often as feasible	Inspect the entire perimeter for cracks, gouges, lack of screw(s) and other signs of tampering. Remove from service if tampering found.
Tamper-evident Sealing Labels		Inspect the sealing labels for scratches, gouges, cuts and other signs of tampering. Remove from service if tampering found.

<u>Exhibit 18</u> - Inspection/Testing of Physical Security Mechanisms (FIPS 140-2 Table C5)







Exhibit 19 – Tamper Evident Label Placement

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Exhibit 20 – Example of Signs of Tamper

NOTE 3: Samsung Electronics Co., L	has excluded the following cor	nponents as per AS01.09:

Items	BOM code	Applicable to Hardware Versions(s)
Capacitor	2203-009819	MZWLL1T9HAJQ-000C9
_		MZWLL3T8HAJQ-000C9
		MZWLL7T6HMLA-000C9
		MZWLL15THMLA-000C9
Capacitor	2203-009821	MZWLL1T9HAJQ-000C9
		MZWLL3T8HAJQ-000C9
		MZWLL7T6HMLA-000C9
		MZWLL15THMLA-000C9
Inductor	2703-004649	MZWLL1T9HAJQ-000C9
		MZWLL3T8HAJQ-000C9
		MZWLL7T6HMLA-000C9
		MZWLL15THMLA-000C9
NAND Flash	K9OMGY8H5A-C###	MZWLL3T8HAJQ-000C9
NAND Flash	K9DVGB8J1M-E###	MZWLL15THMLA-000C9

Exhibit 21 – Excluded components

The components do not process any CSPs, Plaintext data, or other information that if misused could lead to compromise.



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8. Electromagnetic Interference/Electromagnetic Compatibility (EMI/EMC)

The cryptographic module conforms to the EMI/EMC requirements specified by 47 Code of Federal Regulations, Part 15, Subpart B, Unintentional Radiators, Digital Devices, Class B.



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9. Mitigation of Other Attacks Policy

The cryptographic module has not been designed to mitigate any specific attacks beyond the scope of FIPS 140-2.

Other	Mitigation	Specific
Attacks	Mechanism	Limitations
N/A	N/A	N/A

Exhibit 22 - Mitigation of Other Attacks (FIPS 140-2 Table C6)



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10. Security rules

The following specifies the security rules under which the cryptographic module shall operate in accordance with FIPS 140-2:

- The cryptographic module operates always in FIPS Mode once shipped from the vendor's manufacturing site.
- The steps necessary for the secure installation, initialization and start-up of the cryptographic module as per FIPS 140-2 VE10.03.01 are as follows:

10.1. Secure Installation

- Step1. User should examine the tamper evidence
 - Inspect the entire perimeter for cracks, gouges, lack of screw(s) and other signs of tampering including the tamper evident sealing label.
 - If there is any sign of tampering, do not use the product and contact Samsung.
- Step2. Identify the firmware version in the device
 - Confirm that the firmware version is equivalent to the version(s) listed in this document via NVM express Identify Controller command.
- Step3. Take the drive's ownership
 - Disable Admin SP's Admin1 authority
 - Change SID's PIN by setting a new PIN
 - Activate the Locking SP by using the Activate method.
 - Change LockingSP Admin1~4's PIN by setting a new PIN.
 - Configure the Locking Global Range by setting ReadLockEnabled and WriteLockEnabled columns to True.
 - Don't change LockOnReset column in Locking Table so that the drive always gets locked after a power cycle
- Step4. Periodically examine the tamper evidence
 - If there is any sign of tampering, stop using the product to avoid a potential security hazard or information leakage.



10.2. Operational description of Module

- The cryptographic module shall maintain logical separation of data input, data output, control input, status output, and power.
- The cryptographic module shall not output CSPs in any form.
- The cryptographic module shall use the Approved DRBG for generating all cryptographic keys.
- The cryptographic module shall enforce role-based authentication for security relevant services.
- The cryptographic module shall enforce a limited operational environment by the secure firmware load test using ECDSA P-224 with SHA-256.
- The cryptographic module shall provide a production-grade, opaque, and tamper-evident cryptographic boundary.
- The cryptographic module enters the error state upon failure of Self-tests. All commands from the Host (General Purpose Computer (GPC) outside the cryptographic boundary) are rejected in the error state and the cryptographic module returns an Internal Error (SC=0x6, SCT=0x0) defined in NVMe specification via the status output. Cryptographic services and data output are explicitly inhibited when in the error state.
- The cryptographic module satisfies the requirements of FIPS 140-2 IG A.9 (i.e. key_1 ≠ key_2)
- The module generates at a minimum 256 bits of entropy for use in key generation.



10.3. Power-on Self-Tests

11. Algorithm	Test		
AES	Encrypt KAT and Decrypt KAT for AES-256-XTS at power-on		
SHS	KAT for SHA-256 at power-on		
DRBG	KAT for Hash_DRBG (SHA-256) at power-on SP 800-90A Section 11.3 Health Tests		
ECDSA	KAT for ECDSA P-224 SHA-256 signature verification at power-on		

Exhibit 23 – Power-on Self-tests.

- F/W integrity check
 - F/W integrity check is performed by using 106-bit error detection code at power-on
- Conditional Self-tests
 - Pairwise consistency: N/A
 - Bypass Test: N/A
 - Manual key entry test: N/A
 - o F/W load test
 - F/W load test is performed by using ECDSA algorithm with P-224 and SHA-256
 - Continuous random number generator test on Approved DRBG
 - o Continuous random number generator test on NDRNG